

Test Laboratory: Compliance Certification Services
File Name: [RC1 - SO3 8k Enhanced Low - Ch 384.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.52 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

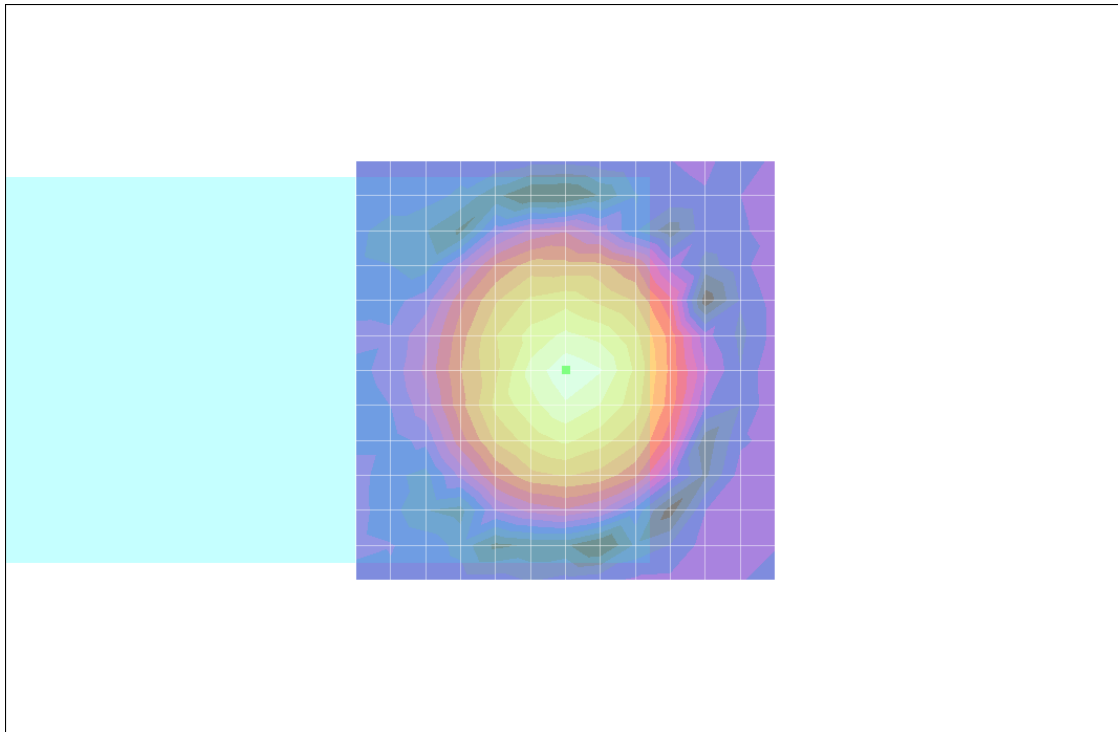
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -0.749601 dB A/m

BWC Factor = 0.00842123 dB

Location: 0, 0, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC2 - SO17 13k Low - Ch 1013.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 824.7 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

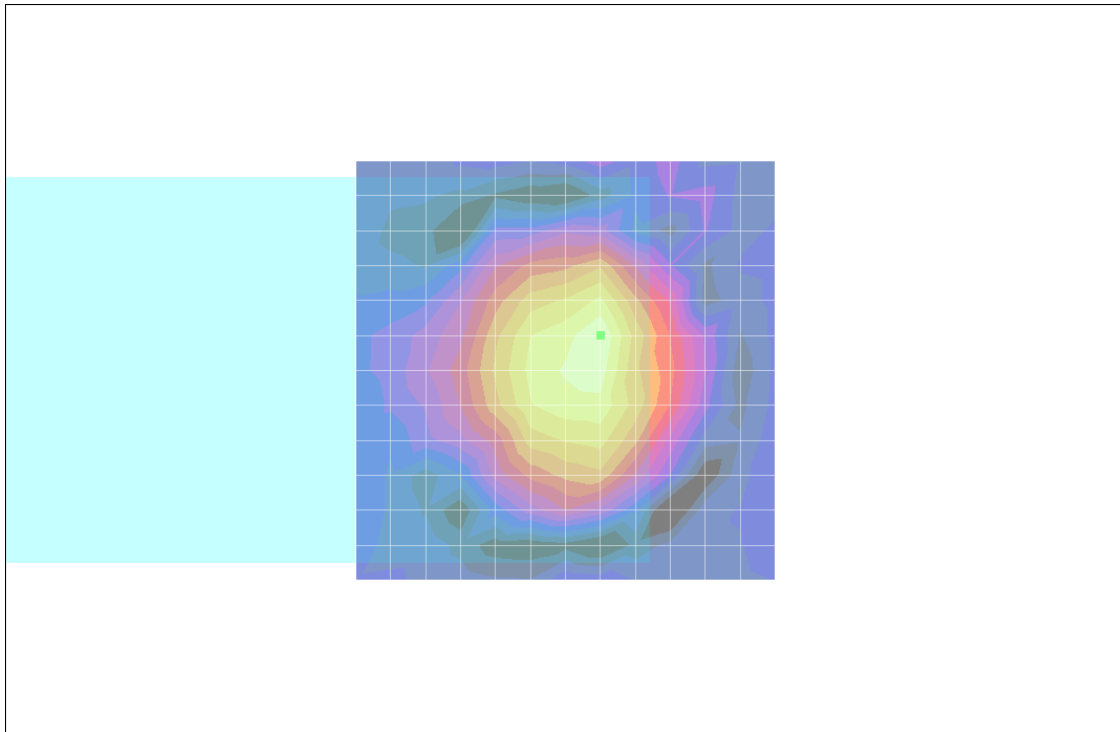
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -3.12462 dB A/m

BWC Factor = 0.00833445 dB

Location: -4.2, -4.2, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC2 - SO17 13k Low - Ch 384.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.52 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

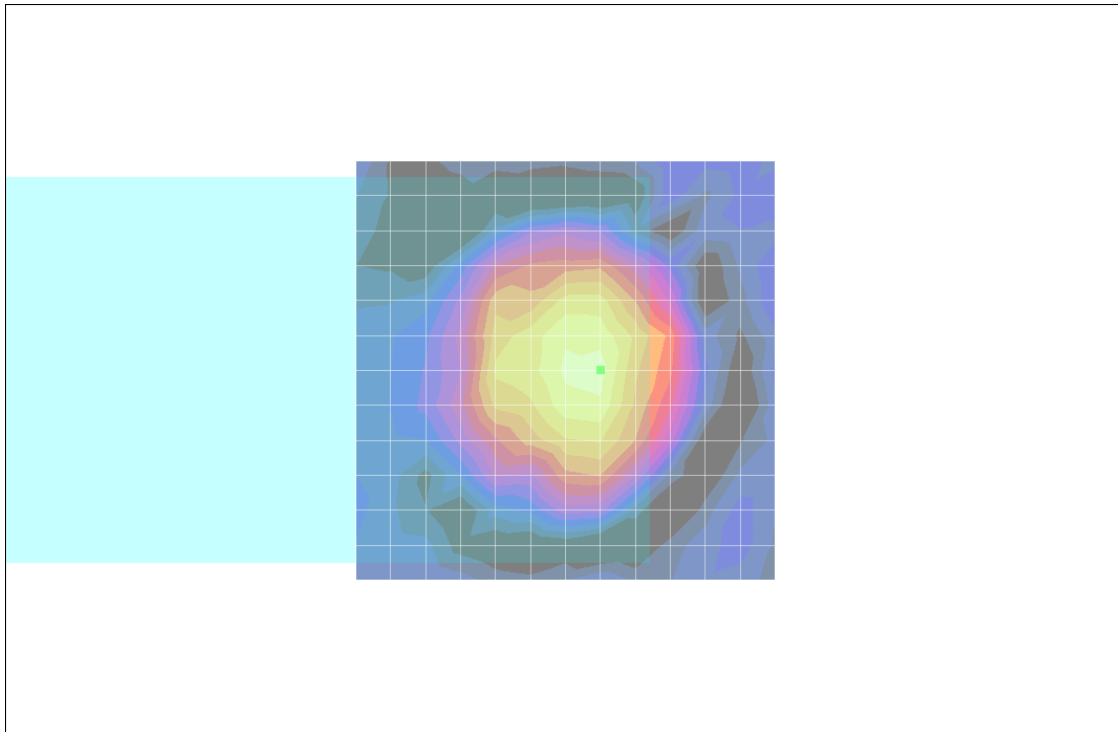
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -4.78025 dB A/m

BWC Factor = 0.00859478 dB

Location: -4.2, 0, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC2 - SO17 13k Low - Ch 777.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 848.31 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

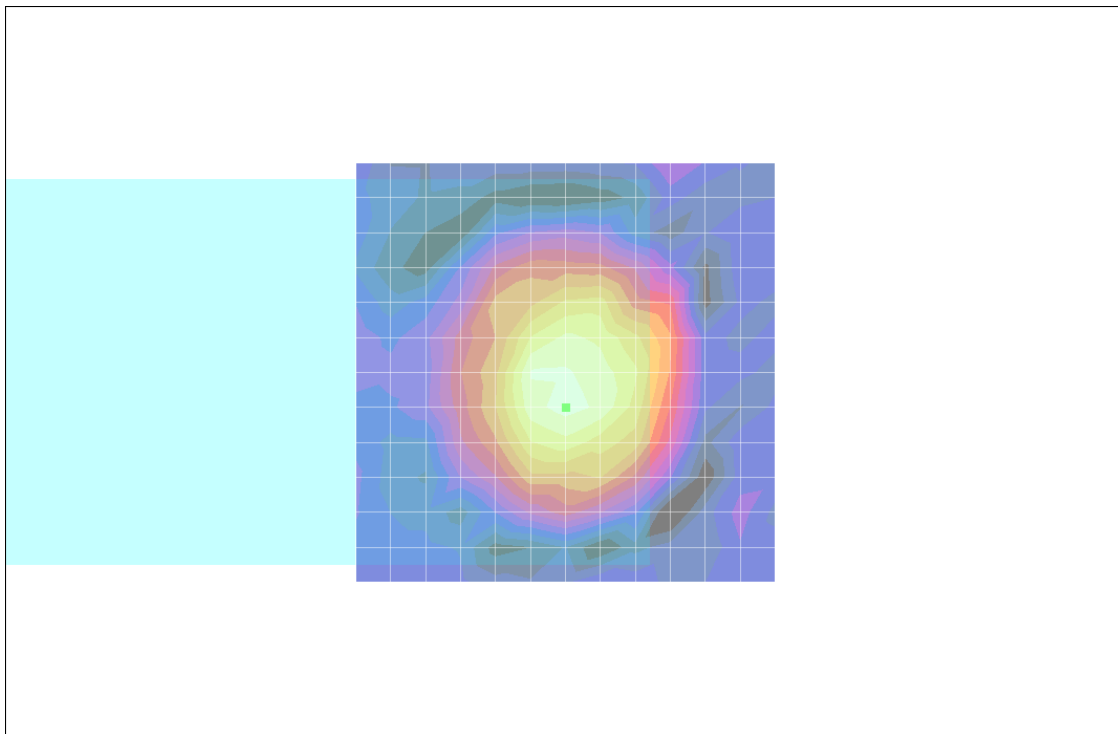
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -1.76391 dB A/m

BWC Factor = 0.00842123 dB

Location: 0, 4.2, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC3 - SO3 8k Enhanced Low - Ch 384.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.52 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³

Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

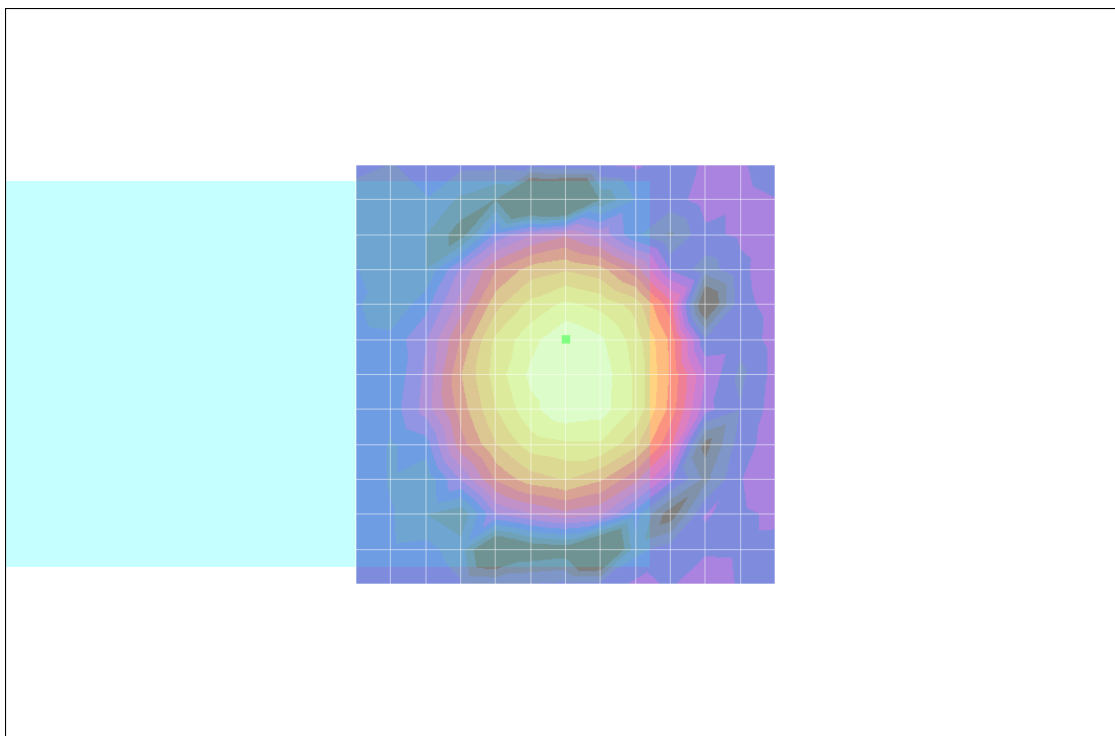
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -3.70165 dB A/m

BWC Factor = 0.00833445 dB

Location: 0, -4.2, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC43 - SO3 8k Enhanced Low - Ch 384.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.52 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³

Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

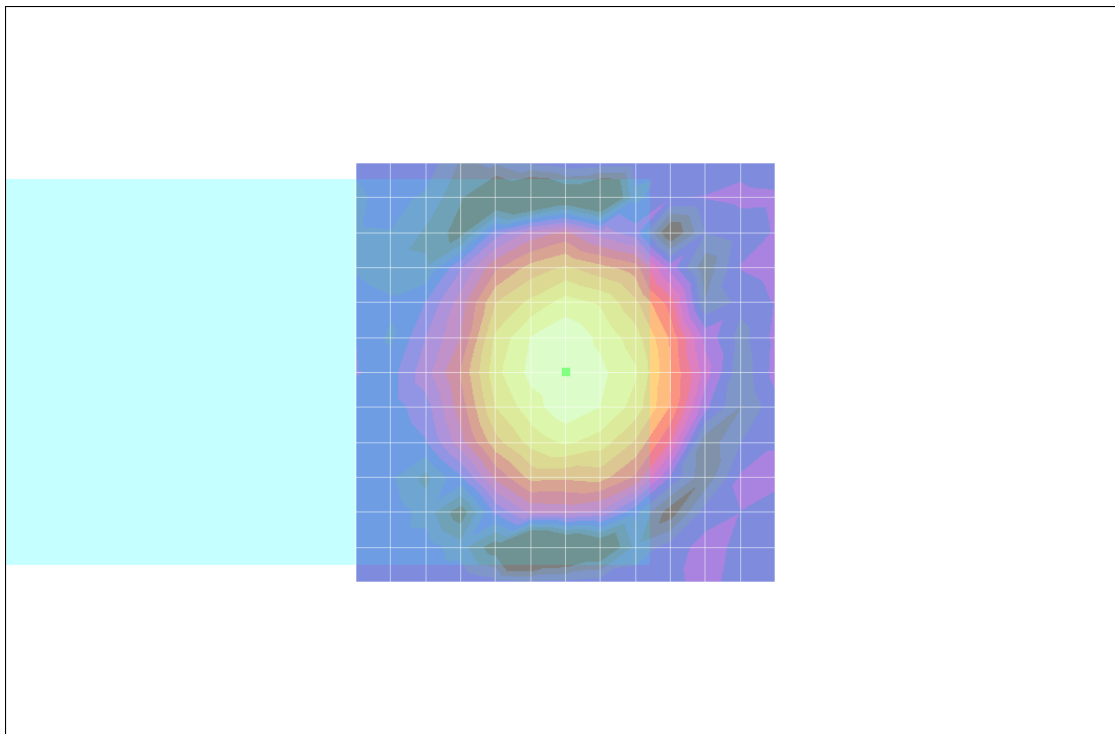
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -3.77694 dB A/m

BWC Factor = 0.00868155 dB

Location: 0, 0, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC54 - SO17 13k Low - Ch 384.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.52 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

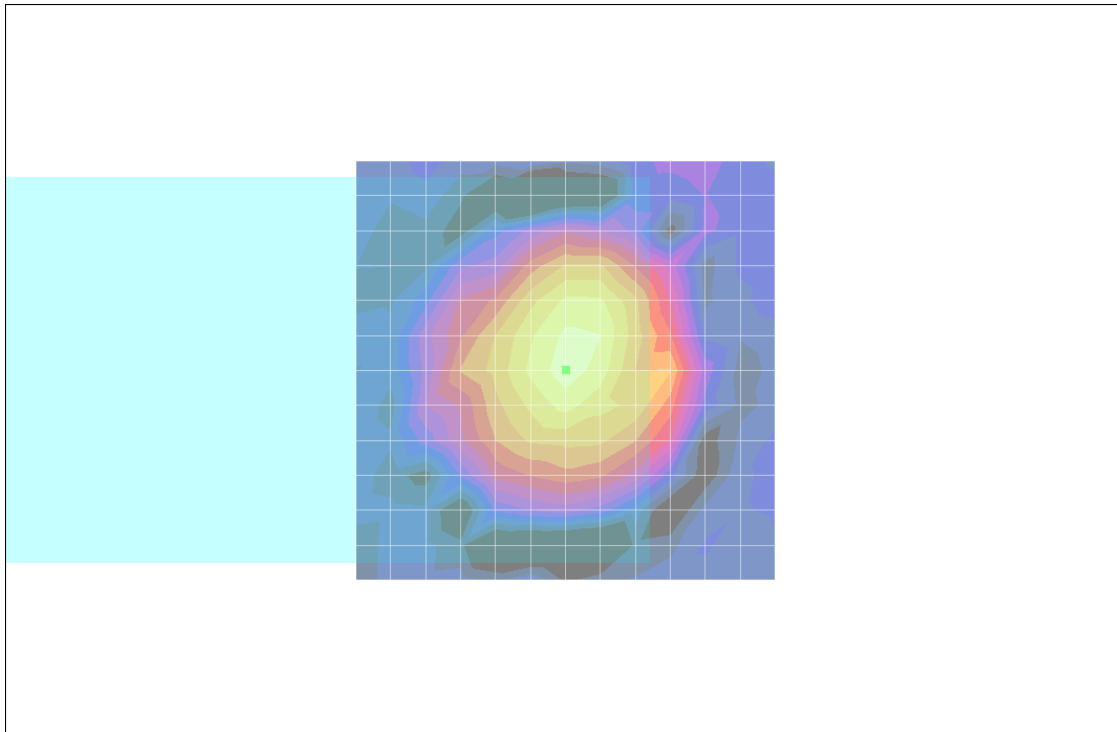
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -4.57324 dB A/m

BWC Factor = 0.00833445 dB

Location: 0, 0, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC1 - SO3 8k Enhanced Low - Ch 600.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³

Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

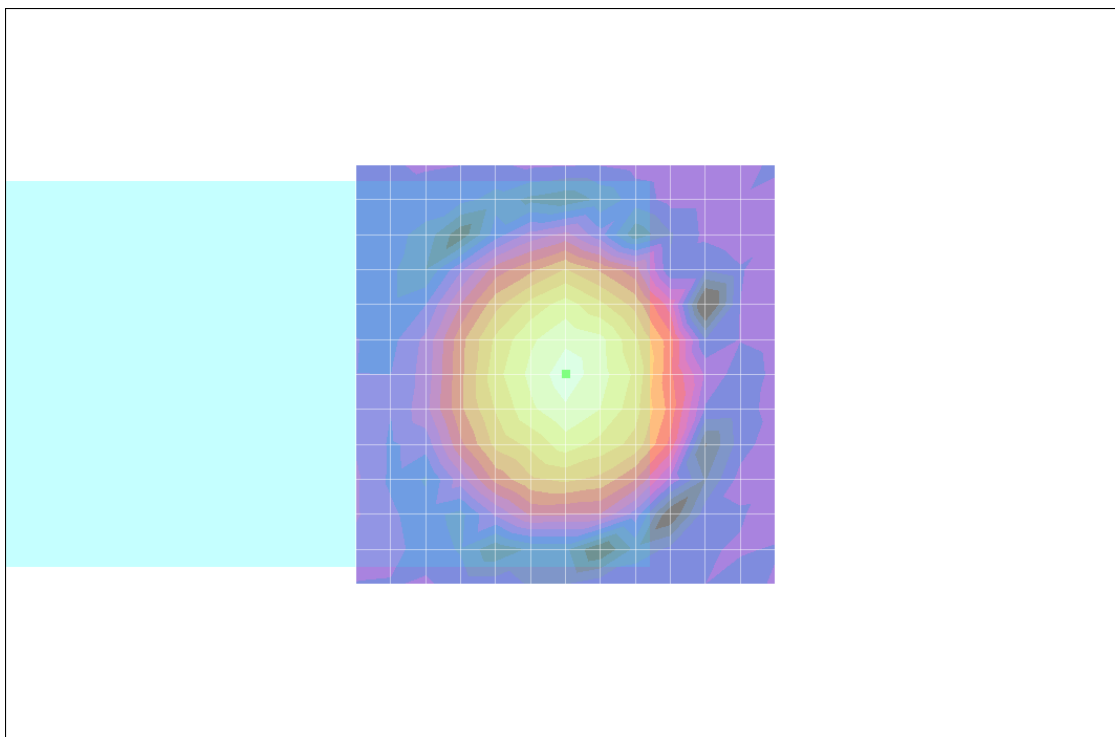
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -1.23023 dB A/m

BWC Factor = 0.0093757 dB

Location: 0, 0, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC2 - SO17 13 Low - Ch 25.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1851.25 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

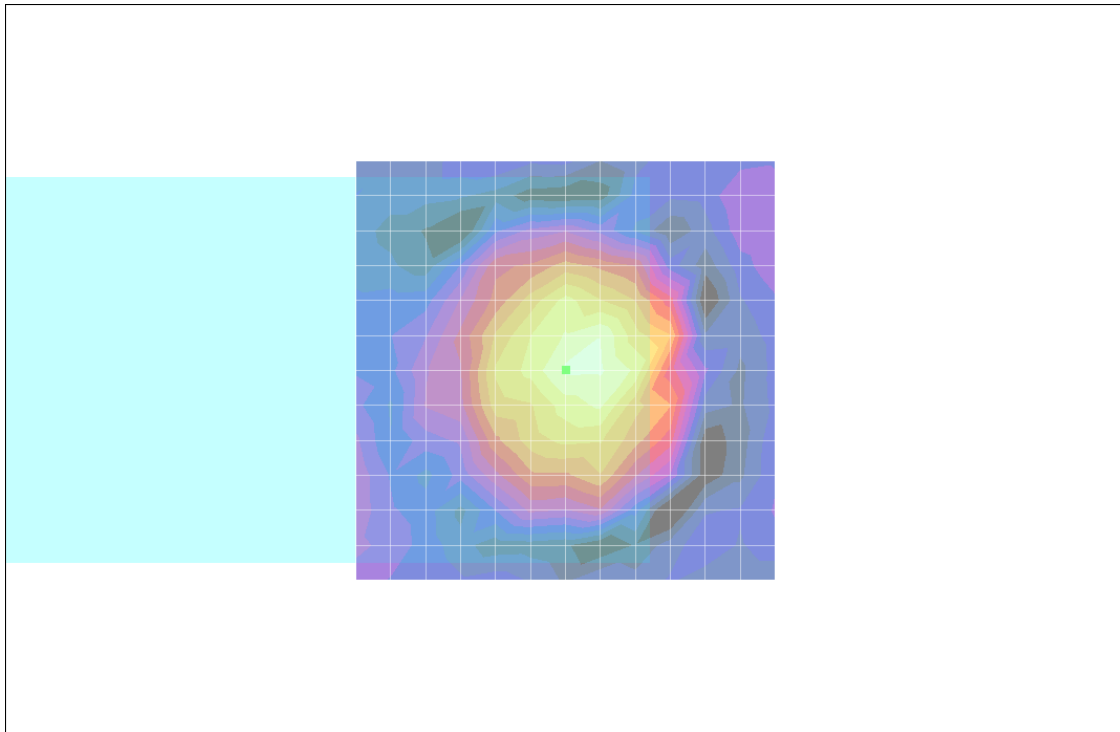
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -2.49317 dB A/m

BWC Factor = 0.00868155 dB

Location: 0, 0, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services

File Name: [RC2 - SO17 13 Low - Ch 600.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³

Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006

- Sensor-Surface: 0mm (Fix Surface)

- Electronics: DAE3 Sn427; Calibrated: 11/16/2006

- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x

- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

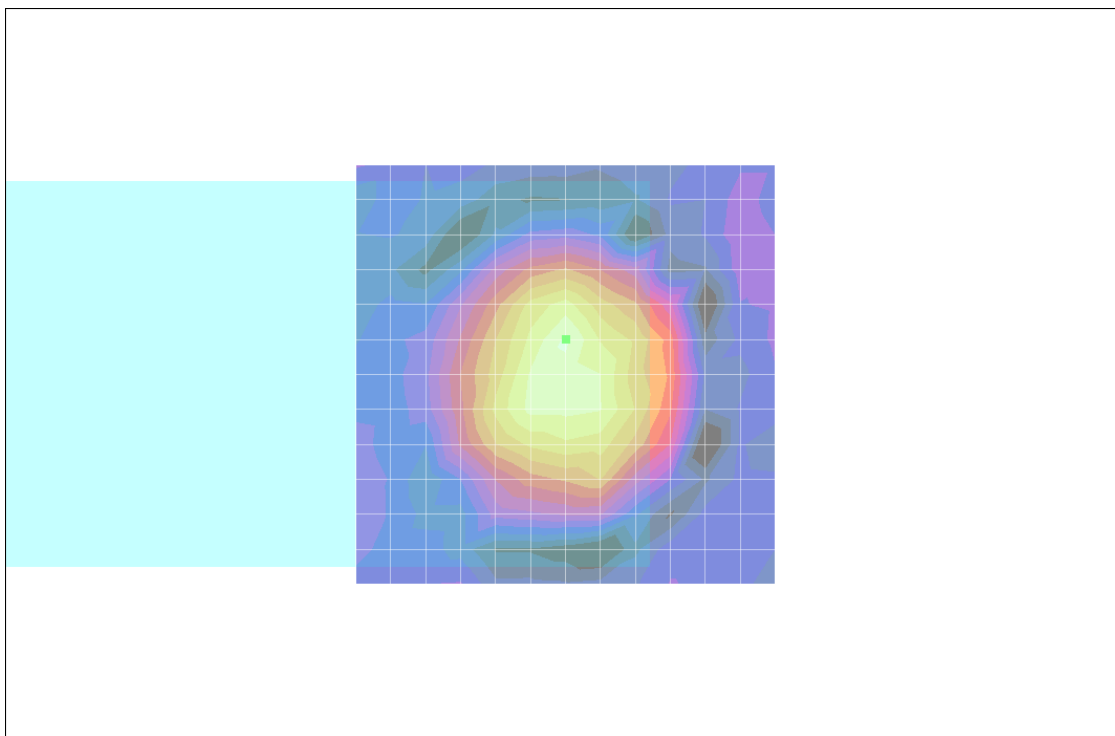
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -2.42524 dB A/m

BWC Factor = 0.00564399 dB

Location: 0, -4.2, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC2 - SO17 13 Low - Ch 1175.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1908.75 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

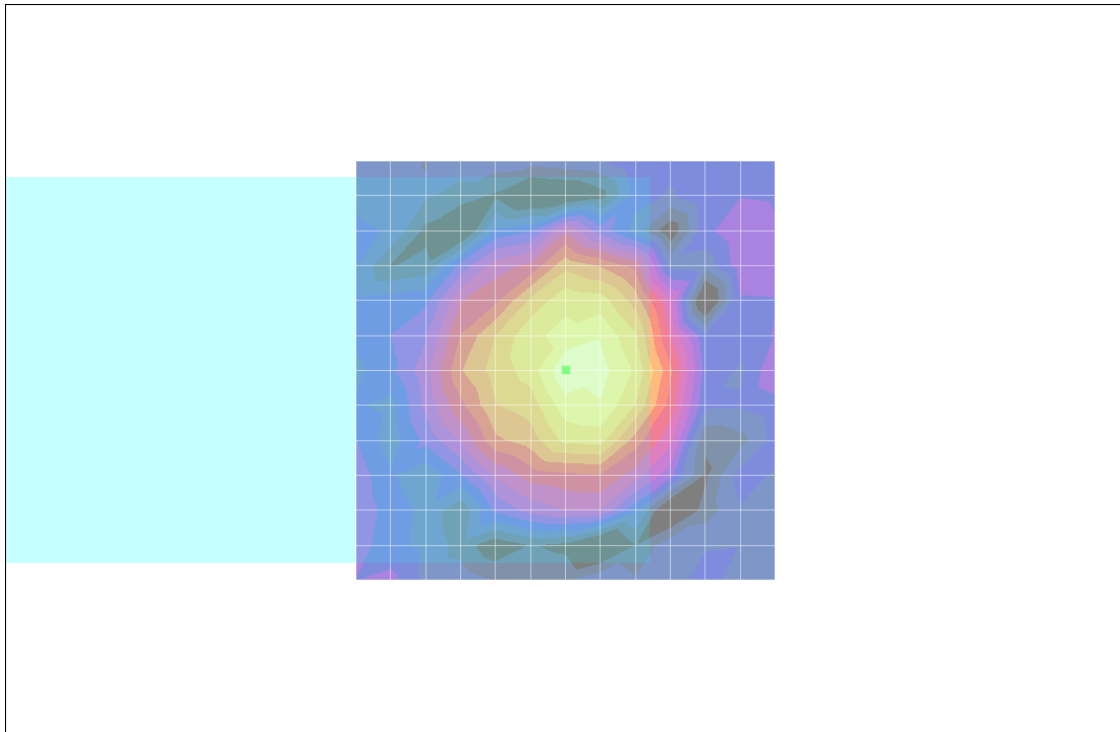
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -3.46281 dB A/m

BWC Factor = -0.0312036 dB

Location: 0, 0, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC3 - SO3 8k Enhanced Low - Ch 600.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

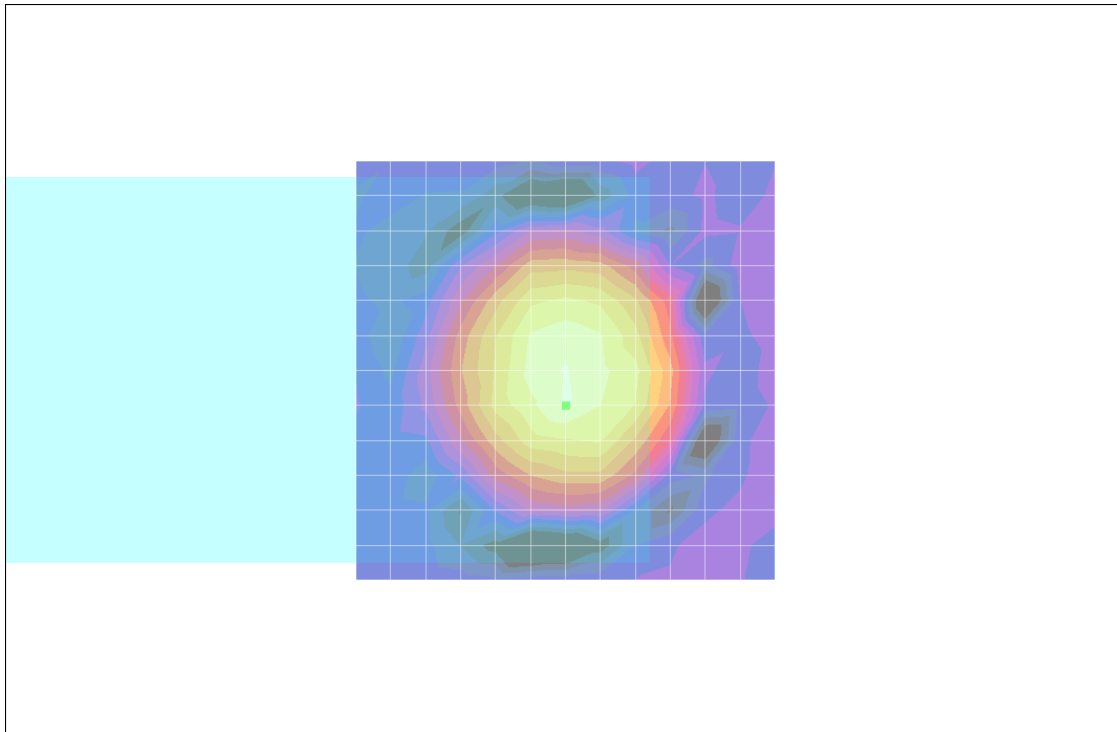
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -2.71497 dB A/m

BWC Factor = 0.00842123 dB

Location: 0, 4.2, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC43 - SO3 8k Enhanced Low - Ch 600.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

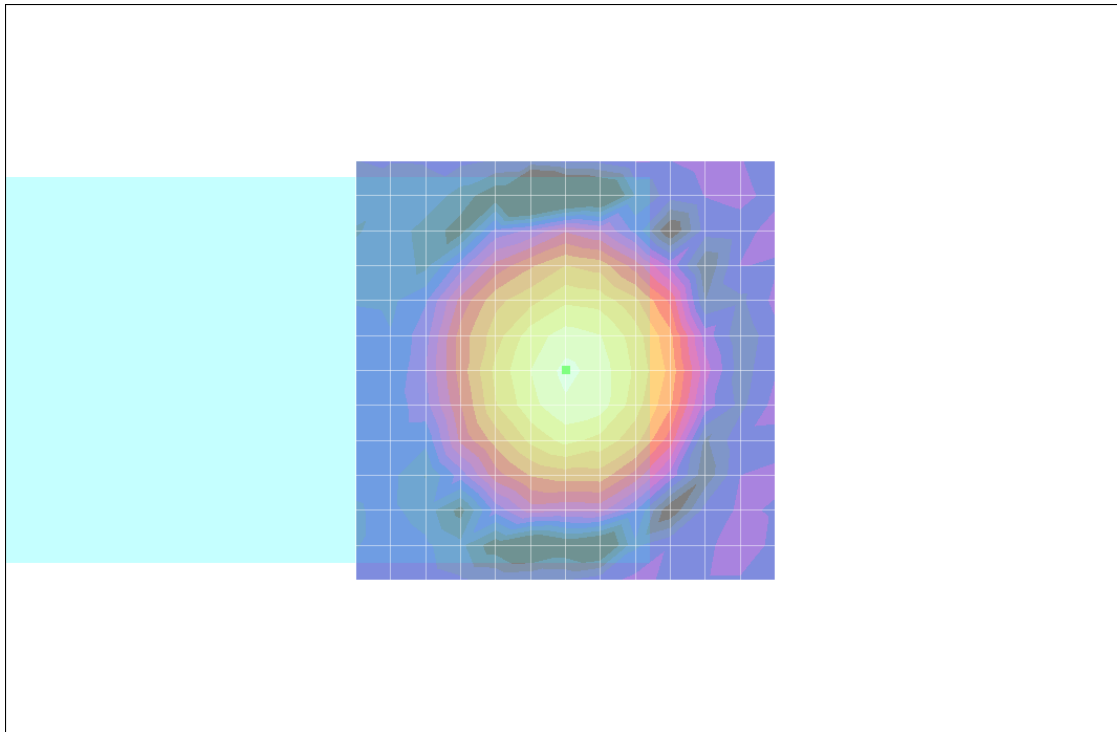
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -2.20213 dB A/m

BWC Factor = 0.00876832 dB

Location: 0, 0, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [RC54 - SO17 13 Low - Ch 600.da4](#)

DUT: Keyocera; Type: cellular Phone; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE3 Sn427; Calibrated: 11/16/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 53; Postprocessing SW: SEMCAD, V1.8 Build 172

Scans/z (axial) medium 4.2mm 50 x 50/ABM Signal(x,y,z) (13x13x1):

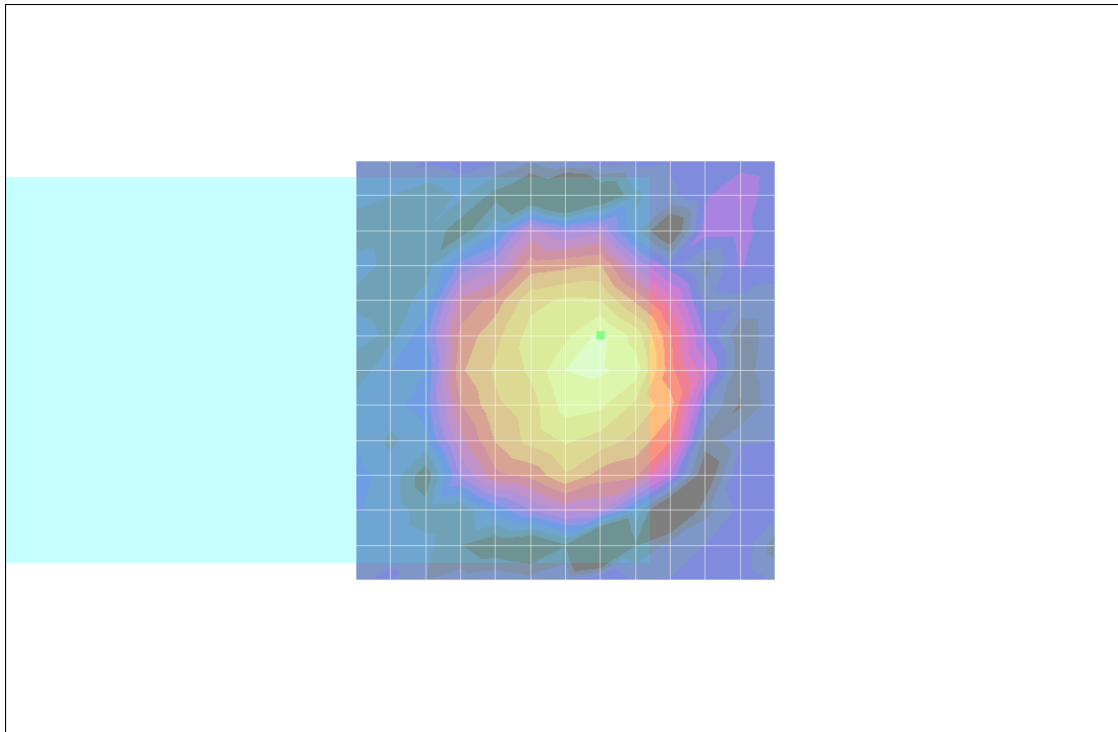
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 comp = -5.43337 dB A/m

BWC Factor = 0.00833445 dB

Location: -4.2, -4.2, 363.7 mm



0 dB = 1.00A/m